PRELIMINARY DATA SHEET

NPN SILICON TRANSISTOR

NE688M13

FEATURES

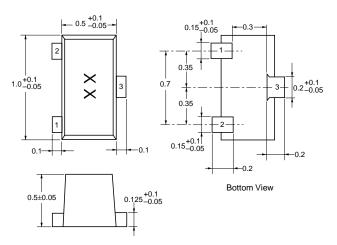
- NEW MINIATURE M13 PACKAGE:
 - Small transistor outline –
 - 1.0 X 0.5 X 0.5 mm
 - Low profile / 0.50 mm package height
 - Flat lead style for better RF performance
- **HIGH GAIN BANDWIDTH PRODUCT:** ft = 9.5 GHz
- LOW NOISE FIGURE: NF = 1.7 dB at 2 GHz
- HIGH COLLECTOR CURRENT: IC MAX = 100 mA

DESCRIPTION

The NE688M13 transistor is designed for low cost amplifier and oscillator applications. Low noise figure, high gain and high current capability equate to wide dynamic range and excellent linearity. NEC's new low profile/flat lead style "M13" package is ideal for today's portable wireless applications. The NE688 is also available in chip and six different low cost plastic surface mount package styles.

OUTLINE DIMENSIONS (Units in mm)

PACKAGE OUTLINE M13



PIN CONNECTIONS

- 1. Emitter
- 2. Base
- 3. Collector

ELECTRICAL CHARACTERISTICS (TA = 25°C)

PART NUMBER EIAJ ¹ REGISTERED NUMBER PACKAGE OUTLINE			NE688M13 2SC5616 M13			
SYMBOLS	PARAMETERS AND CONDITIONS	UNITS	MIN	ТҮР	МАХ	
f⊤	Gain Bandwidth at VCE = 1 V, IC = 3 mA, f = 2 GHz VCE = 3 V, IC = 20 mA, f = 2 GHz	GHz GHz	4	5 9.5		
NF	Noise Figure at VcE = 1 V, Ic = 3 mA, f = 2 GHz VcE = 3 V, Ic = 7 mA, f = 2 GHz	dB dB		1.9 1.7	2.5	
S21E ²	Insertion Power Gain at Vce = 1 V, Ic = 3 mA, f = 2 GHz Vce = 3 V, Ic = 20 mA, f = 2 GHz	dB dB	3	4 8		
hfe ²	Forward Current Gain at VcE = 1 V, Ic = 3 mA		80		145	
Ісво	Collector Cutoff Current at VCB = 5 V, IE = 0	μΑ			0.1	
Іево	Emitter Cutoff Current at VEB = 1 V, Ic = 0	μA			0.1	
Cre ³	Feedback Capacitance at VCB = 1 V, IE = 0, f = 1 MHz	pF		0.7	0.8	

Notes:

1. Electronic Industrial Association of Japan.

2. Pulsed measurement, pulse width \leq 350 $\mu s,$ duty cycle \leq 2 %.

3. Capacitance is measured with emitter and case connected to the guard terminal at the bridge.

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SYMBOLS	PARAMETERS	UNITS	RATINGS
Vсво	Collector to Base Voltage	V	9
Vceo	Collector to Emitter Voltage	V	6
Vebo	Emitter to Base Voltage	V	2
lc	Collector Current	mA	100
PT ²	Total Power Dissipation	mW	140
TJ	Junction Temperature	°C	150
Tstg	Storage Temperature	°C	-65 to +150

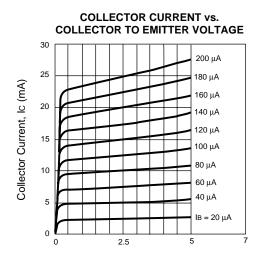
ABSOLUTE MAXIMUM RATINGS¹ (TA = 25°C)

Notes:

1. Operation in excess of any one of these parameters may result in permanent damage.

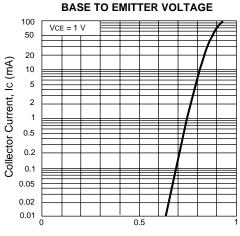
2. With device mounted on 1.08 cm² X 1.2 mm glass epoxy board.

TYPICAL PERFORMANCE CURVES (TA = 25°C)

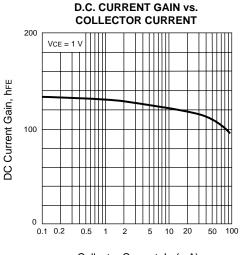


Collector to Emmiter Voltage, VCE (V)

COLLECTOR CURRENT vs.



Base to Emmiter Voltage, VBE (V)



Collector Current, Ic (mA)

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